



# Product Change Notification

**Change Notification #:** 116545 - 00  
**Change Title:** Intel® Wireless-AC3165 2230:  
 3165.NGWG, 3165.NGWG.S,  
 PCN 116545-00, Label, Label Update  
**Date of Publication:** October 16, 2018

**Key Characteristics of the Change:**  
 Label

**Forecasted Key Milestones:**

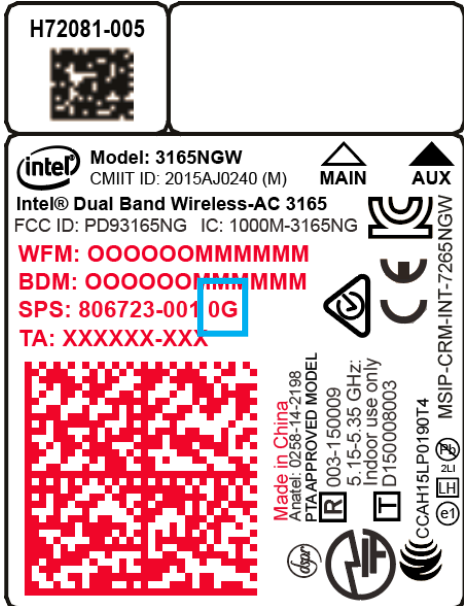
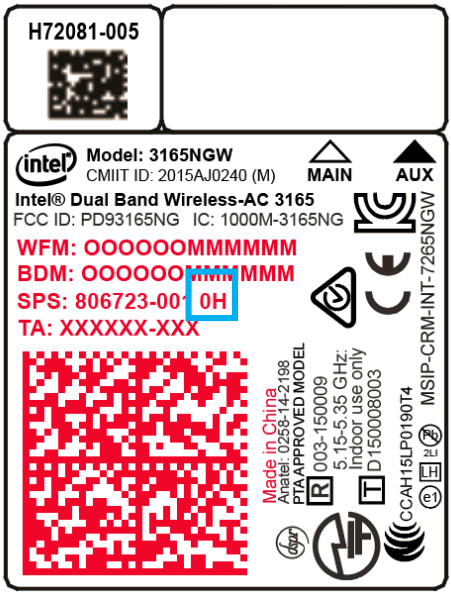
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	November 8, 2018
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**Description of Change to the Customer:**

The Intel® Wireless-AC3165 2230 SKUs listed in the products affected table below will undergo the following changes

1. Date code tables are being updated for 2019/2020.
2. The Intel tracking revision will be changed on the following product.

Product	Before	After
3165.NGWG	0G	0H

Product Code	Product Label (Before)	Product Label (After)
3165.NGWG		

3165.NGWG IBL Label (Before)

<b>3165.NGWG</b> <b>MM#: XXXXXX</b> QTY: 100 	Intel® Dual Band Wireless-AC 3165 (Model: 3165NGW) PKG ID (3S) VVVVMMMMDDDD###PPPPPP100 T P/N: GTTTTTTTTTT	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LU</td><td>LX</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td></tr> </table> Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LU	LX	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
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VERSION #: XXXXXX-XXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXX	D P/N: P P P P P P    REV AX X    HP P/N: XXXXXX-XXX RE : 0G Vendor ID   Loc Id    Mfg Id    L P/N: XXXXXXXXXXXX VVVVVLLLLL    M M M M M M    EC: XXXXXXXX	CNC ID: C-14446 MSIP-CRM-INT-XXXXXXXX																																			

3165.NGWG IBL Label (After)

<b>3165.NGWG</b> <b>MM#: XXXXXX</b> QTY: 100 	Intel® Dual Band Wireless-AC 3165 (Model: 3165NGW) PKG ID (3S) VVVVMMMMDDDD###PPPPPP100 T P/N: GTTTTTTTTTT	<table border="1"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LU</td><td>LX</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td></tr> </table> Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LU	LX	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
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**Customer Impact of Change and Recommended Action:**

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
3165.NGWG	940106	H71304-009	H71304-010
3165.NGWG.S	940107	H72060-007	H72060-008

**PCN Revision History:**

<b>Date of Revision:</b> October 16, 2018	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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# Product Change Notification

## 116545 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apagccb@intel.com](mailto:apagccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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